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ON Semiconductor®

FDP5500-F085

N-Channel UltraFET Power MOSFET

55V, 80A, $7m\Omega$

Features

- Typ $r_{DS(on)}$ = 5.1m Ω at V_{GS} = 10V, I_D = 80A
- Typ $Q_{g(10)}$ = 114nC at V_{GS} = 10V
- Simulation Models
 - -Temperature Compensated PSPICE and SABER $^{\mathsf{TM}}$ Models
- Peak Current vs Pulse Width Curve
- UIS Rating Curve
- Qualified to AEC Q101
- RoHS Compliant

Applications

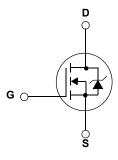
- DC Linear Mode Control
- Solenoid and Motor Control
- Switching Regulators
- Automotive Systems



Package



Symbol



MOSFET Maximum Ratings $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter		Ratings	Units
V_{DSS}	Drain to Source Voltage	(Note 1)	55	V
V_{DGR}	Drain to Gate Voltage ($R_{GS} = 20k\Omega$)	(Note 1)	55	V
V_{GS}	Gate to Source Voltage		±20	V
	Drain Current Continuous (T _C < 135°C, V _{GS} = 10V)		80	А
'D	Pulsed		See Figure 4	^
E _{AS}	Single Pulse Avalanche Energy	(Note 2)	860	mJ
D	Power Dissipation		375	W
P_D	Derate above 25°C		2.5	W/oC
T _J , T _{STG}	Operating and Storage Temperature		-55 to + 175	
T _L	Max. Lead Temp. for Soldering (at 1.6mm from case for 10sec)		300	οС
T _{pkg}	Max. Package Temp. for Soldering (Package Body for 10sec)		260	

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance Junction to Case	0.4	°C/W
$R_{\theta JA}$	Thermal Resistance Junction to Ambient TO-220AB, 1in ² copper pad area	62	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDP5500	FDP5500-F085	TO-220AB	Tube	N/A	50 units

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Cha	racteristics					

B _{VDSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0$	/	55	-	-	V
I _{DSS} Zero Gate Voltage Drain Current	$V_{DS} = 50V, V_{GS} = 0$	V	-	-	1	цΑ	
	Zero Gate voltage Drain Current	$V_{DS} = 45V$	$T_{\rm C} = 150^{\rm o}{\rm C}$	-	-	250	μΑ
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V$		-	-	±100	nA

On Characteristics

V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	2	2.8	4	V
r _{DS(on)}	Drain to Source On Resistance	$I_D = 80A, V_{GS} = 10V$	ı	5.1	7	mΩ

Dynamic Characteristics

C _{iss}	Input Capacitance)/ OF)/)/	V _{DS} = 25V, V _{GS} = 0V, f = 1MHz	-	3565	-	pF
Coss	Output Capacitance			-	1310	-	pF
C _{rss}	Reverse Transfer Capacitance	1 - 1101112		-	395	-	pF
$Q_{g(TOT)}$	Total Gate Charge at 20V	$V_{GS} = 0$ to 20V		-	207	269	nC
Q _{g(10)}	Total Gate Charge at 10V	V _{GS} = 0 to 10V	$V_{DD} = 30V$	-	114	148	nC
$Q_{g(TH)}$	Threshold Gate Charge	$V_{GS} = 0$ to 2V	$I_D = 80A$ $R_1 = 0.4\Omega$	-	6.6	8.6	nC
Q _{gs}	Gate to Source Gate Charge		$I_{c} = 1.0 \text{mA}$	-	17.2	-	nC
Q _{gd}	Gate to Drain "Miller" Charge		g	-	52	-	nC

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units

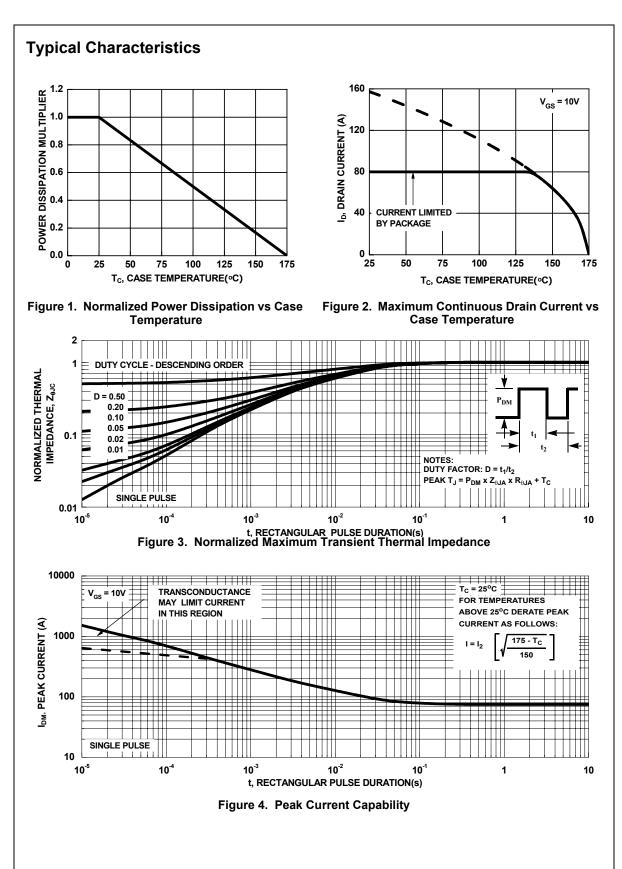
Switching Characteristics

t _{on}	Turn-On Time	$V_{DD} = 30V, I_D = 80A,$ $R_L = 0.4\Omega, V_{GS} = 10V,$ $R_{GS} = 2.5\Omega$	-	-	75	ns
t _{d(on)}	Turn-On Delay Time		-	12	-	ns
t _r	Rise Time		-	34	-	ns
t _{d(off)}	Turn-Off Delay Time		-	37	-	ns
t _f	Fall Time		-	23	-	ns
t _{off}	Turn-Off Time		-	-	96	ns

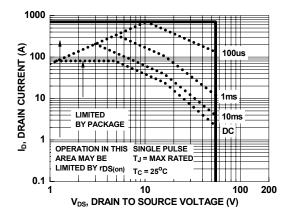
Drain-Source Diode Characteristics

V_{SD}	Source to Drain Diode Voltage	I _{SD} = 80A	-	0.9	1.25	V
t _{rr}	Reverse Recovery Time	$I_F = 80A$, $dI_{SD}/dt = 100A/\mu s$	-	58	75	ns
Q _{rr}	Reverse Recovery Charge		-	71	92	nC

Starting T_J = 25°C to175°C.
 Starting T_J = 25°C, L = 0.42mH, I_{AS} = 64A



Typical Characteristics



1000

(Y)

If R = 0

tay = (L)(I_{AS})/(1.3*RATED BV_{DSS} - V_{DD})

If R ≠ 0

tay = (L)(I_{AS})/(1.3*RATED BV_{DSS} - V_{DD}) +1]

STARTING T_J = 150°C

STARTING T_J = 150°C

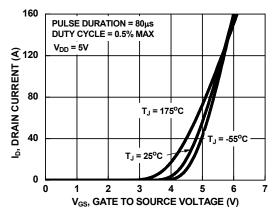
1 0.01 0.1 1 10 100 1000 5000

t_{AV}, TIME IN AVALANCHE (ms)

Figure 5. Forward Bias Safe Operating Area

NOTE: Refer to ON Semiconductor Application Notes AN7514 and AN7515

Figure 6. Unclamped Inductive Switching Capability



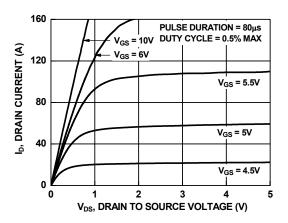
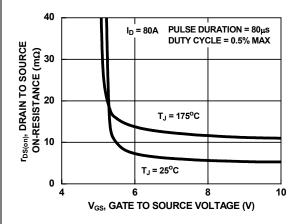


Figure 7. Transfer Characteristics

Figure 8. Saturation Characteristics



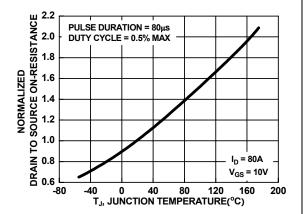


Figure 9. Drain to Source On-Resistance Variation vs Gate to Source Voltage

Figure 10. Normalized Drain to Source On Resistance vs Junction Temperature

Typical Characteristics

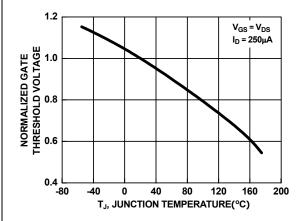


Figure 11. Normalized Gate Threshold Voltage vs
Junction Temperature

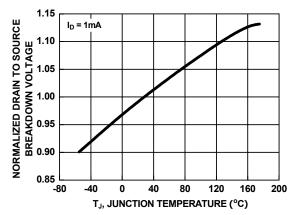


Figure 12. Normalized Drain to Source Breakdown Voltage vs Junction Temperature

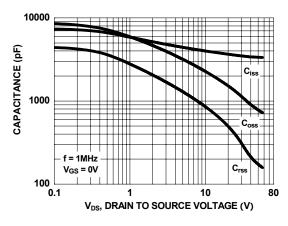


Figure 13. Capacitance vs Drain to Source Voltage

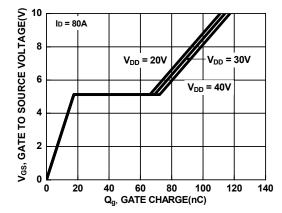


Figure 14. Gate Charge vs Gate to Source Voltage

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